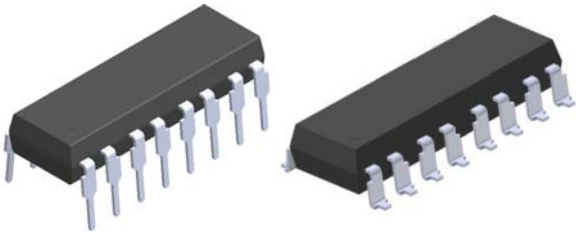


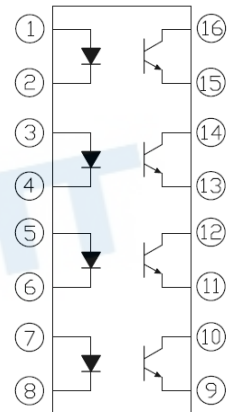
## 16 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL847 Series



### Features:

- Current transfer ratio (CTR: 50~600% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$ )
- High isolation voltage between input and output ( $V_{iso} = 5000\text{ V rms}$ )
- Creepage distance  $> 7.62\text{ mm}$
- Operating temperature up to  $+110^\circ\text{C}$
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Pb free
- UL and cUL approved (No. E214129)
- VDE approved
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

### Schematic



1, 3, 5, 7	Anode
2, 4, 6, 8	Cathode
9, 11, 13, 15	Emitter
10, 12, 14, 16	Collector

### Description

The EL847 series devices each of consist of an infrared emitting diodes, optically coupled to a phototransistor detector, and provides four isolated channels. They are packaged in a 16-pin DIP package and available in SMD option.

### Applications

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

**Absolute Maximum Ratings (T<sub>A</sub>=25°C, for each channel)**

	Parameter	Symbol	Rating	Unit
Input	Forward Current	I <sub>F</sub>	60	mA
	Peak Forward Current (1us, pulse)	I <sub>FP</sub>	1	A
	Reverse Voltage	V <sub>R</sub>	6	V
	Power Dissipation	P <sub>D</sub>	100	mW
Output	Power Dissipation	P <sub>C</sub>	150	mW
	Collector Current	I <sub>C</sub>	50	mA
	Collector-Emitter Voltage	V <sub>CEO</sub>	80	V
	Emitter-Collector Voltage	V <sub>ECO</sub>	7	V
	Total Power Dissipation	P <sub>TOT</sub>	200	mW
	Isolation Voltage *1	V <sub>ISO</sub>	5000	V rms
	Operating Temperature	T <sub>OPR</sub>	-55 to 110	°C
	Storage Temperature	T <sub>STG</sub>	-55 to 125	°C
	Soldering Temperature *2	T <sub>SOL</sub>	260	°C

Notes:

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1~8 are shorted together, and pins 9~16 are shorted together.

\*2 For 10 seconds

**Electro-Optical Characteristics (T<sub>A</sub>=25°C unless specified otherwise)**

**Input**

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward Voltage	V <sub>F</sub>	-	1.2	1.4	V	I <sub>F</sub> = 20mA
Reverse Current	I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> = 4V
Input Capacitance	C <sub>in</sub>	-	30	250	pF	V = 0, f = 1kHz

Note: Reverse Voltage(V<sub>R</sub>) Condition is applied to I<sub>R</sub> test only The device is not designed for reverse operation

**Output**

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Collector-Emitter Dark Current	I <sub>CEO</sub>	-	-	100	nA	V <sub>CE</sub> = 20V, I <sub>F</sub> = 0mA
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	80	-	-	V	I <sub>C</sub> = 0.1mA
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	7	-	-	V	I <sub>E</sub> = 0.1mA

**Transfer Characteristics**

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Current Transfer Ratio	CTR	50	-	600	%	I <sub>F</sub> = 5mA , V <sub>CE</sub> = 5V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	0.1	0.2	V	I <sub>F</sub> = 20mA , I <sub>C</sub> = 1mA
Isolation Resistance	R <sub>IO</sub>	5×10 <sup>10</sup>	-	-	Ω	V <sub>IO</sub> = 500Vdc, 40~60% R.H.
Floating Capacitance	C <sub>IO</sub>	-	0.6	1.0	pF	V <sub>IO</sub> = 0, f = 1MHz
Cut-off Frequency	f <sub>c</sub>	-	80	-	kHz	V <sub>CE</sub> = 5V, I <sub>C</sub> = 2mA R <sub>L</sub> = 100Ω, -3dB
Rise Time	t <sub>r</sub>	-	6	18	μs	V <sub>CE</sub> = 2V, I <sub>C</sub> = 2mA, R <sub>L</sub> = 100Ω
Fall Time	t <sub>f</sub>	-	8	18	μs	

\* Typical values at T<sub>A</sub>= 25°C

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

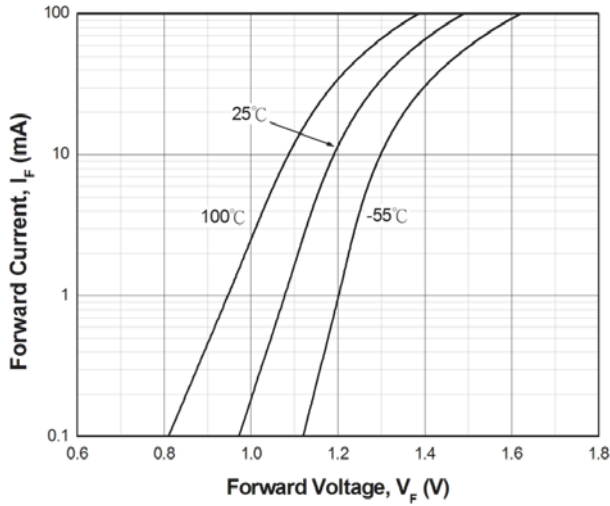


Figure 2. Normalized Collector Current vs Forward Current

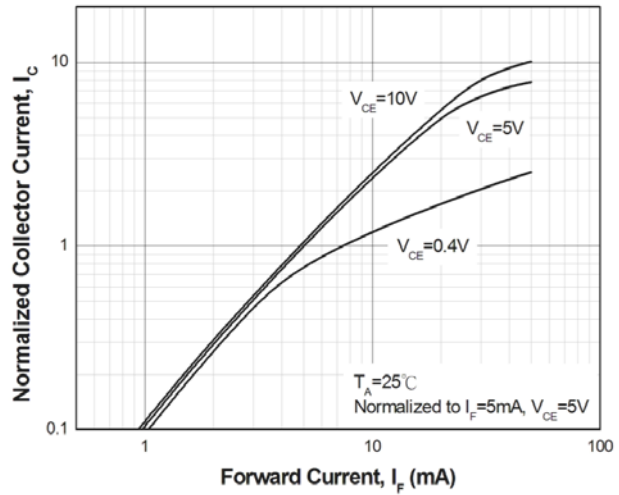


Figure 3. Normalized Current Transfer Ratio vs Forward Current

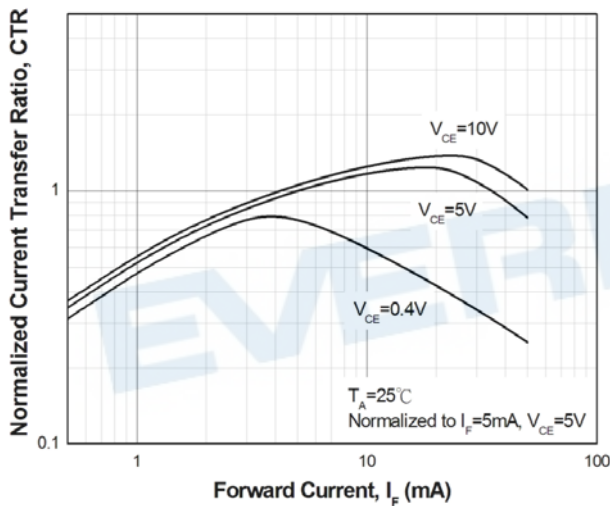


Figure 4. Normalized Collector Current vs Ambient Temperature

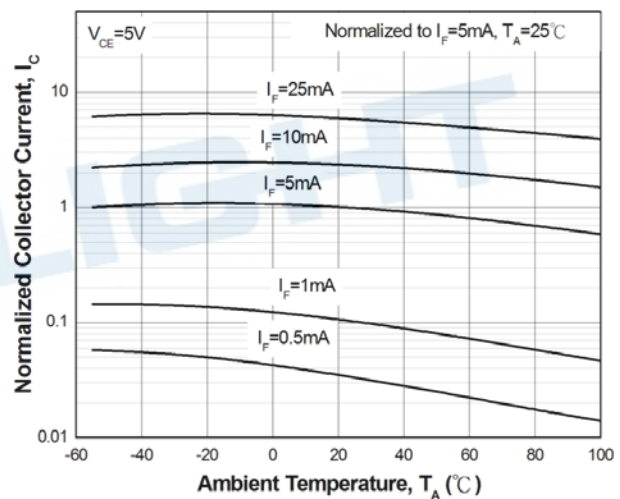


Figure 5. Collector Current vs Collector-Emitter Voltage

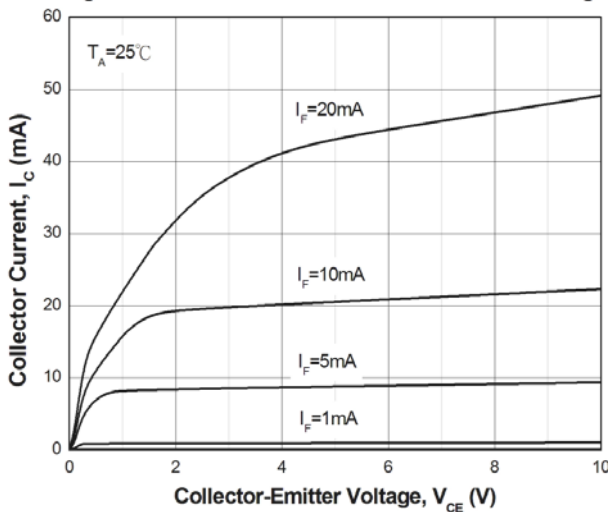


Figure 6. Collector Current vs Collector-Emitter Voltage

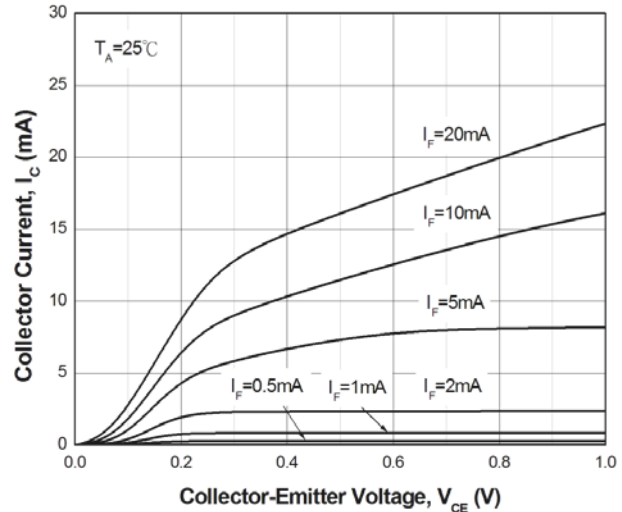


Figure 7. Collector Dark Current vs Ambient Temperature

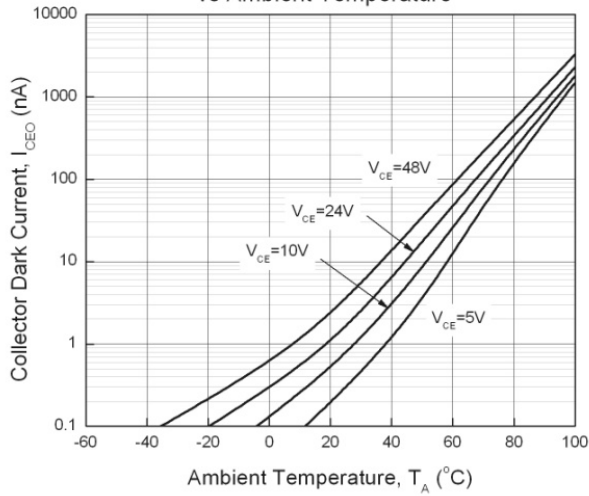


Figure 8. Switching Time vs Load Resistance

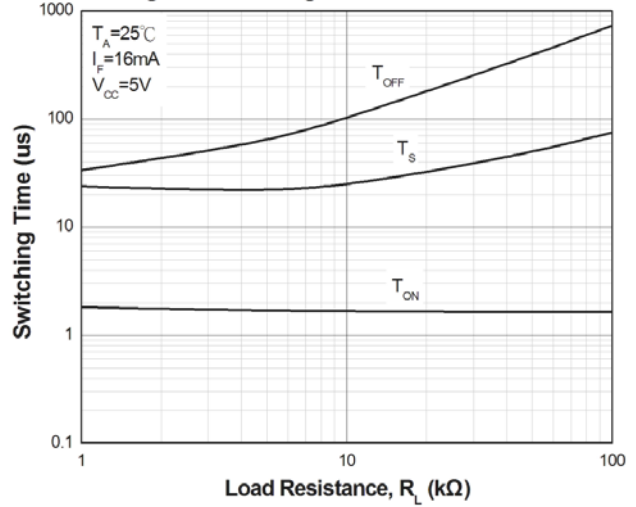
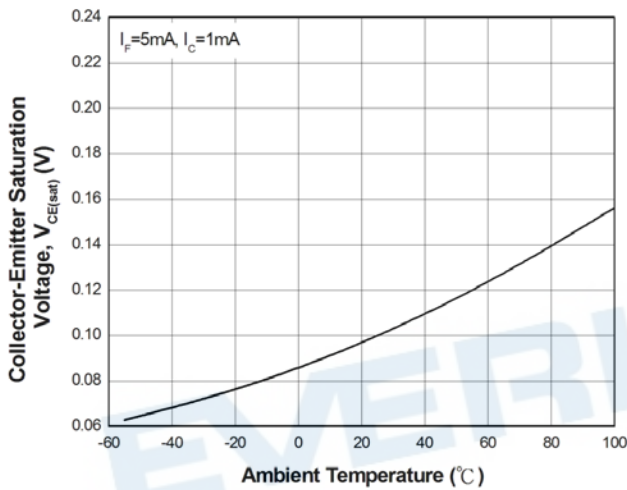


Figure 9. Collector-Emitter Saturation Voltage vs Ambient Temperature



Note: The graphs shown in this datasheet are representing typical data only and do not show guaranteed values

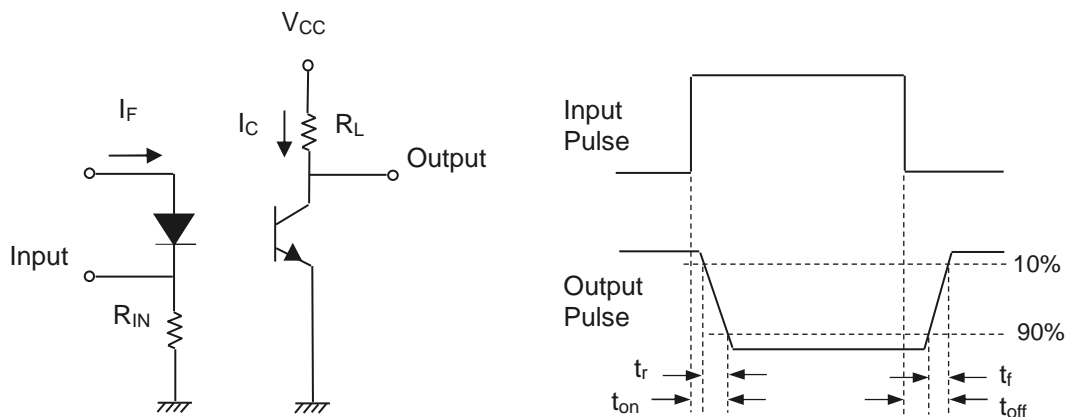


Figure 10. Switching Time Test Circuit & Waveforms

## Order Information

### Part Number

**EL847X-V**

### Note

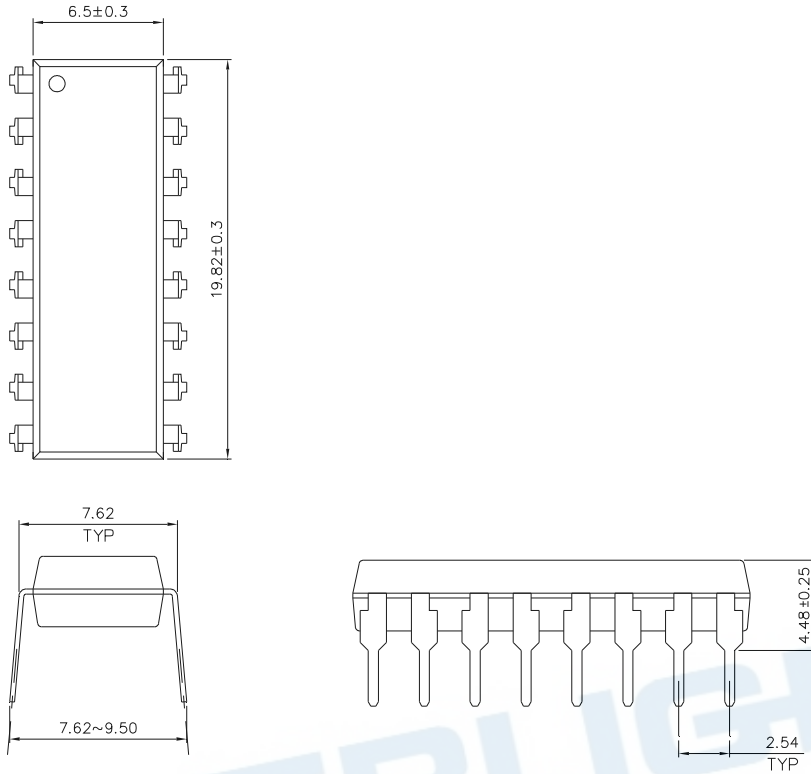
- X = Lead form option (S or none)
- V = VDE safety (optional).

Option	Description	Packing quantity
None	Standard DIP-16	20 units per tube
S	Surface mount lead form	800 units per reel

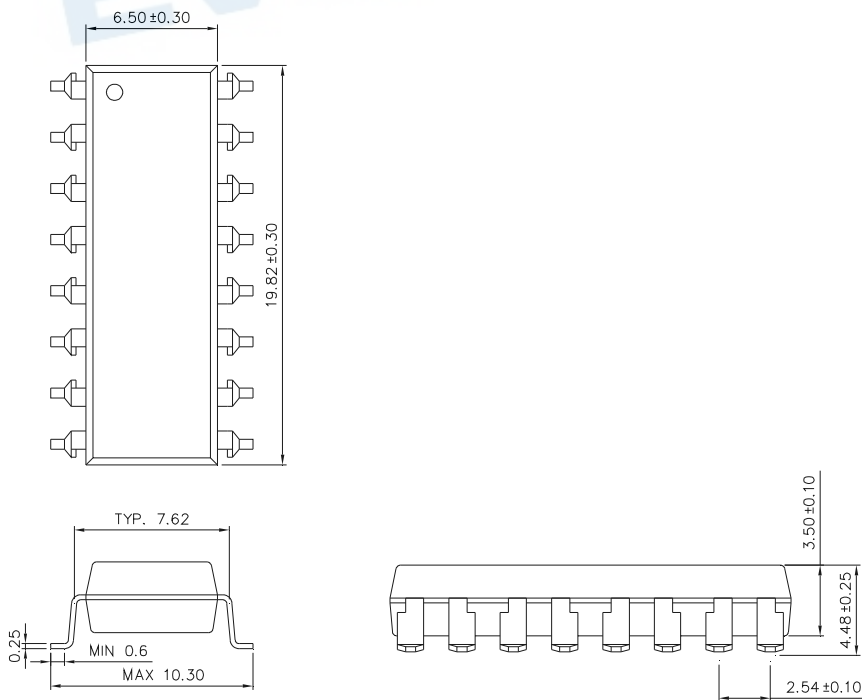
EVERLIGHT

### Package Dimension (Dimensions in mm)

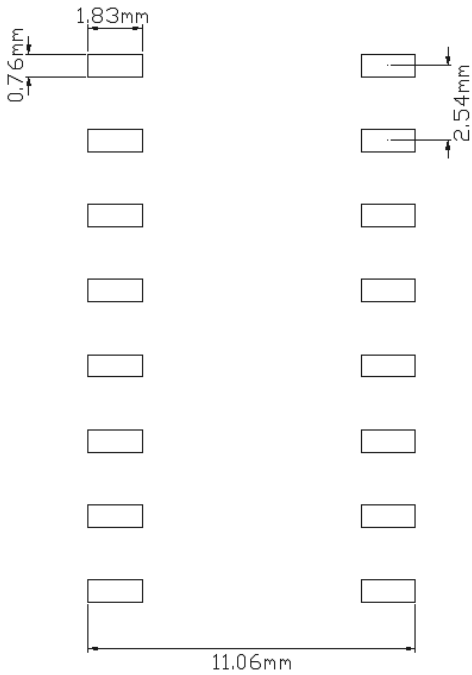
#### Standard DIP Type



#### Option S Type



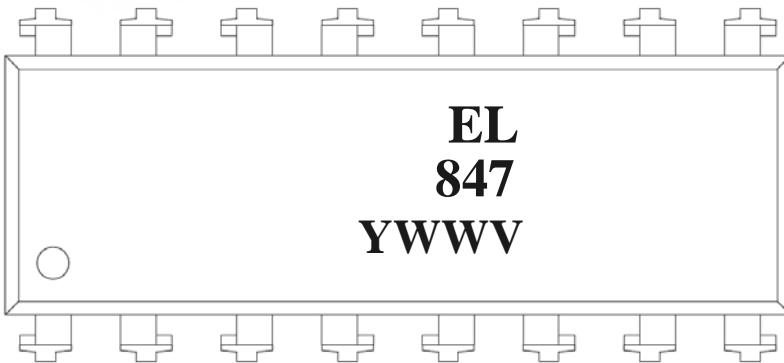
### Recommended pad layout for surface mount leadform



#### Notes

Suggested pad dimension is just for reference only.  
Please modify the pad dimension based on individual need.


### Device Marking





#### Notes


EL847 denotes Device Number  
Y denotes 1 digit Year code  
WW denotes 2 digit Week code  
V denotes VDE (optional)



Label form



**EVERLIGHT**
11 → 月份

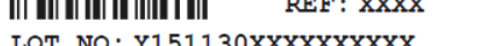

客戶料號 ← CPN: XXXXXXXXXXXX 測試區
  → RoHS標示

億光料號 ← P/N: XXXXXXXXXXXX
  → 安規標示

億光品名 ← EL817M(C)-VG
   



生產週別 ← D/C: YWWX      CAT: X      QTY: 000000
   
      REF: XXXX       → 包裝數量


生產序號 ← LOT NO: Y151130XXXXXXXXXX
   


標籤識別碼 ← REFERENCE: BTPyyMMddXXXXX
   

 → QR Code


產地 ← MADE IN XXXXXX



OR



RoHS 標示
   

**EVERLIGHT**
5 → 月份

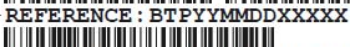

客戶料號 ← CPN: XXXXXXXXXXXX 測試區
  → 安規標示

客戶品名 ← XXXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX
   
 億光料號 ← P/N: XXXXXXXXXXXX
   
 億光品名 ← XXXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX

生產序號 ← LOT NO: Y150516XXX-XXXXXXXXXX-XXXXXXXXXX
   


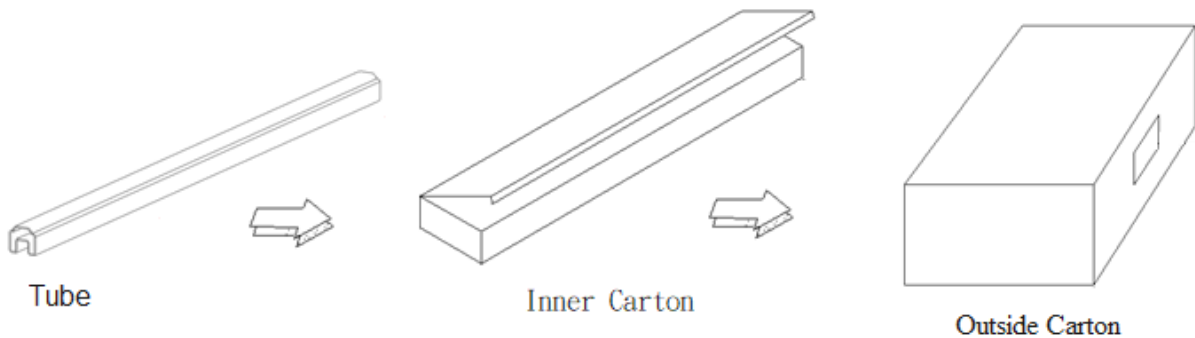
包裝數量 ← QTY: 0123456789      HUE: XXXXXXXXXXXX
   
      

CTR等級 ← CAT: XXXXXXXXXXXX      REF: XXXXXXXXXXXX
   
      

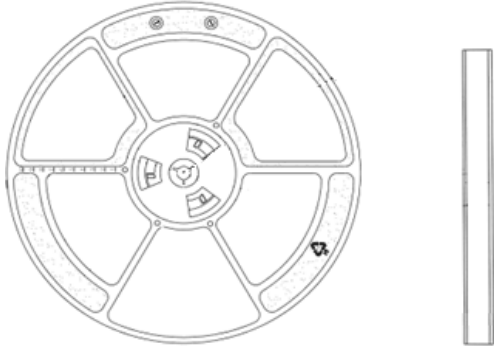
標籤識別碼 ← REFERENCE: BTPYMMDDXXXXX
   

 → QR Code

MSL等級 ← MSL-XX      MADE IN XXXXXX
   
↓
  
 產地

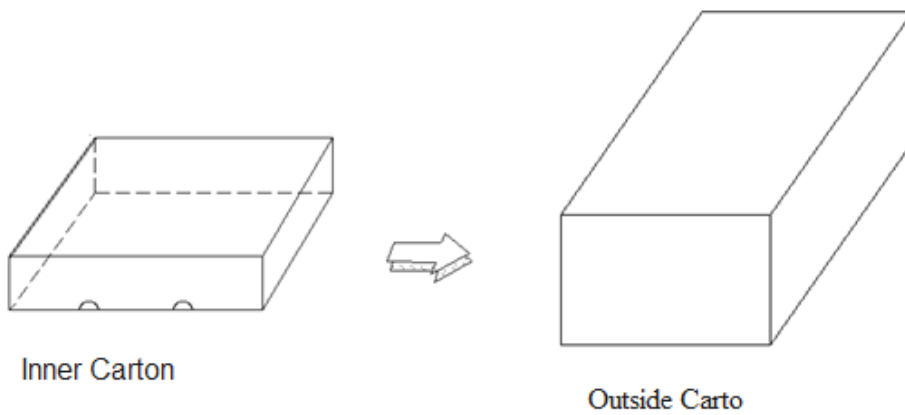
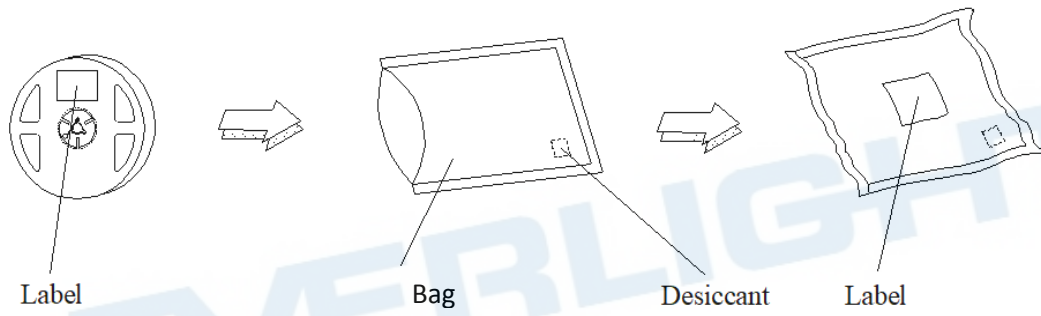
TUBE Dimension



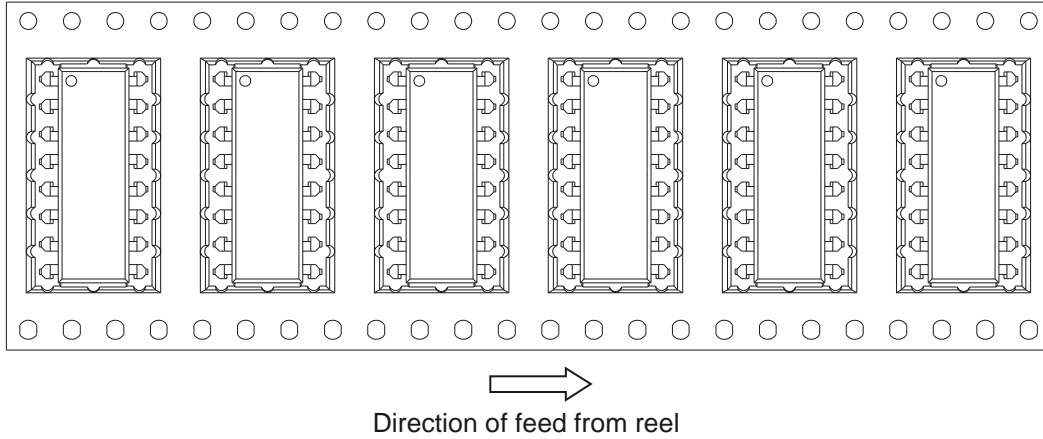
### Reel Dimension



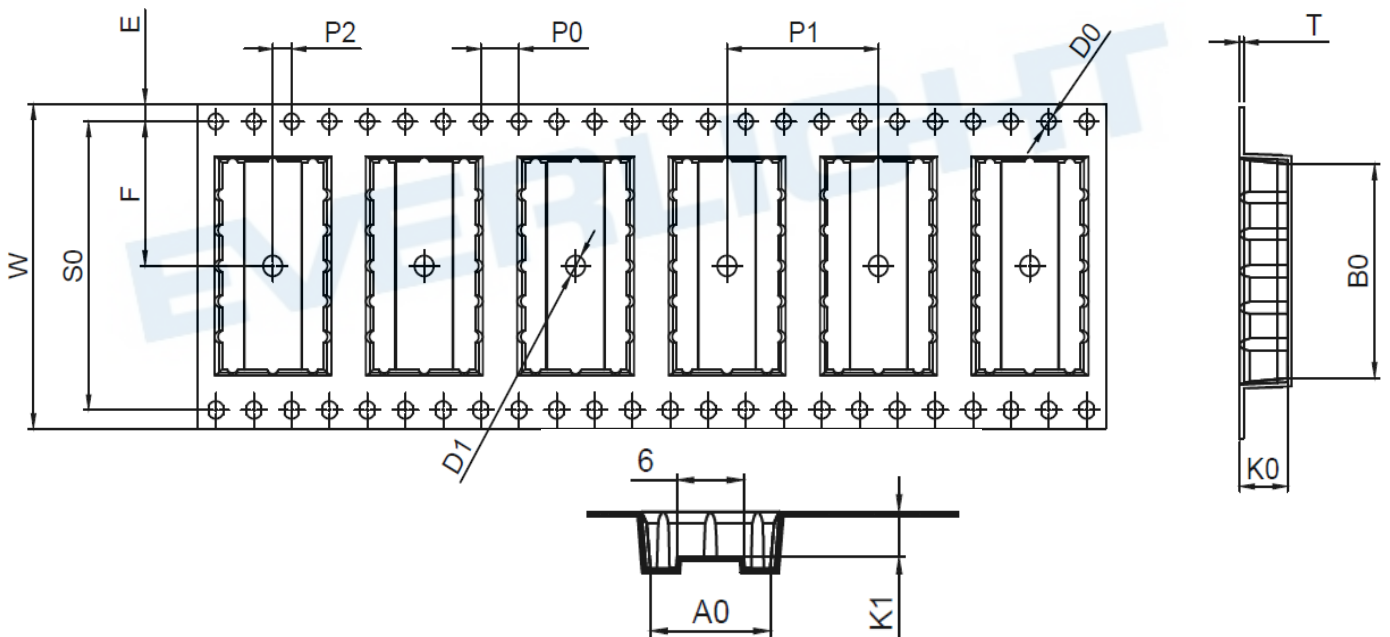
### Moisture Resistant Packaging



### Tape & Reel Packing Specifications



### Tape dimensions

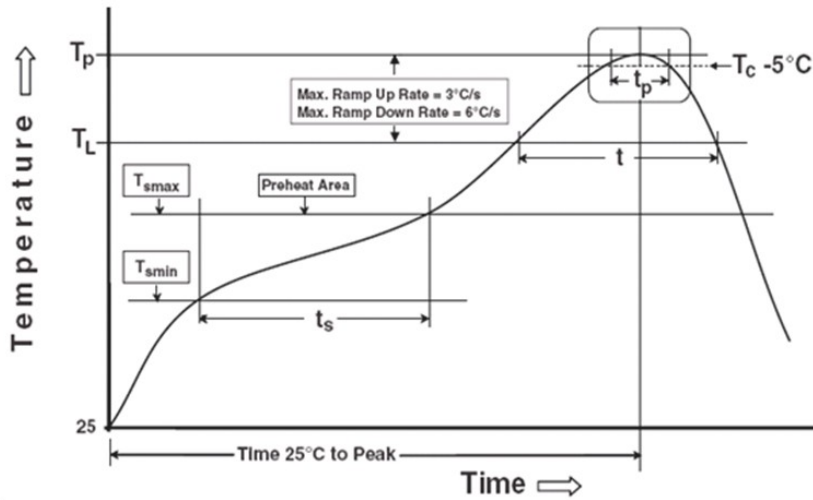


Dimension No.	<b>W</b>	<b>E</b>	<b>F</b>	<b>Do</b>	<b>D<sub>1</sub></b>	<b>P0</b>	<b>P1</b>
Dimension (mm)	32.00±0.3	1.75±0.1	14.2±0.1	1.50±0.1	2.00±0.1	4.00±0.1	16.00±0.1
Dimension No.	<b>P2</b>	<b>Ao</b>	<b>Bo</b>	<b>Ko</b>	<b>K<sub>1</sub></b>	<b>T</b>	<b>So</b>
Dimension (mm)	2.00±0.1	10.75±0.1	20.45±0.1	4.85±0.1	3.85±0.1	0.40±0.1	28.40±0.1

## Precautions for Use

### 1. Soldering Condition

#### 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

#### Preheat

Temperature min ( $T_{smin}$ )	150 °C
Temperature max ( $T_{smax}$ )	200°C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max

#### Other

Liquidus Temperature ( $T_L$ )	217 °C
Time above Liquidus Temperature ( $t_L$ )	60-100 sec
Peak Temperature ( $T_P$ )	260°C
Time within 5 °C of Actual Peak Temperature: $T_P - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

## Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5°C to 35°C and 20 % to 60 %, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

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